

Discription

The HDF2B6.8E,L3F protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



SOD-523

Features

- ★ Small Body Outline Dimensions
- ★ Low Body Height
- ★ Peak Power up to 90 Watts @ 8 x 20 _s Pulse
- ★ Low Leakage current
- ★ Response Time is Typically < 1 ns</p>
- ★ ESD Rating of Class 3 (> 16 kV) per Human Body Model
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ IEC61000-4-4 Level 4 EFT Protection



Circuit Diagram

Orderingin formation

Product ID	Pack	Qty(PCS)
HDF2B6.8E,L3F	SOD-523	3000

Absolute Ratings(Tamb = 25°C)

Symbol	Parameter	Value	Units	
P _{PP}	Peak Pulse Power (t _p = 8/20 μ s)	90	W	
TL	Maximum lead temperature for soldering during	260	°C	
T _{stg}	Storage Temperature Range	-55 to +155	°C	
T _{op}	Operating Temperature Range	-40 to +125	°C	
Tj	Maximum junction temperature	150	°C	
	IEC61000-4-2 (ESD)	air discharge contact discharge	±15 ±8	KV
	IEC61000-4-4 (EFT)		40	Α
	ESD Voltage P	er Human Body Model	16	KV

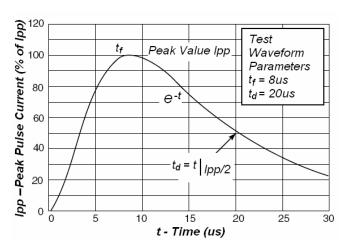


Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.VF = 0.9V at IF = 10mA

Device	V _{RWM} (V)	I _R (uA) @ V _{RWM}	V _{BR} (V)@ I _T (Note 1)		I _T	V _c (V) @ I _{PP} =5 A*	V _C (V) @ Max I _{PP} *	I _{PP} (A)*	P _{PK} (W)*	C (pF)
	Max	Max	Min	Max	mA	Тур	Max	Max	Max	Тур
HDF2B6.8E,L3F	5.0	1	5.6	7.8	1.0	11.6	18.6	9	100	15

100

Typical Characteristics



90 80 70 % of Rated Power 60 50 Peak Pluse Power 40 8/20µs 30 20 10 0 25 75 100 125 150 Lead Temperature- $TL(\mathcal{C})$

Fig1. Pulse Waveform

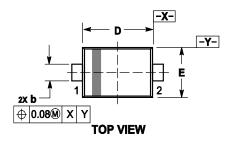
Fig2.Power Derating

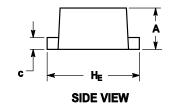
^{*}Surge current waveform per Figure 1.

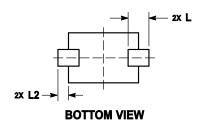
^{1.} V_{BR} is measured with a pluse test current I_T at an ambient temperature of 25°C.



Outline And Dimensions





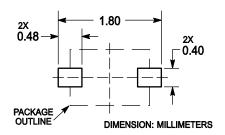


Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.60	0.70	0.020	0.024	0.028
b	0.25	0.30	0.35	0.010	0.012	0.014
С	0.07	0.14	0.20	0.003	0.006	0.008
D	1.10	1.20	1.30	0.043	0.047	0.051
Е	0.70	0.80	0.90	0.028	0.031	0.035
H _E	1.50	1.60	1.70	0.059	0.063	0.067
L	0.30 REF			0.012 REF		
L ₂	0.15	0.20	0.25	0.006	0.008	0.010

Soledering Footprint





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